



Docket No. 51821

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

APPLICANT(S): Barclay et al. EXAMINER: S. Lee
SERIAL NO.: 10/690,217 GROUP: 1752
FILED: October 21, 2003
FOR: PHOTORESIST CONTAINING SI-POLYMERS

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

DECLARATION UNDER 37 CFR 1.132

The undersigned declares as follows:

1. I, George G. Barclay, am a co-inventor of the above-identified patent application (the "Application") which is assigned to the Shipley Company, L.L.C.


2. I understand that certain claims of the Application have been rejected by the patent Examiner in view of U.S. Patent Application Publication 2003/0224286, copy attached, also assigned to Shipley Company, L.L.C. The co-inventors of U.S. Patent Application Publication 2003/0224286 are George G. Barclay, Subareddy Kanagasabapathy and Matthew A. King. Of those co-inventors of U.S. Patent Application Publication 2003/0224286, George G. Barclay and Subareddy Kanagasabapathy are co-inventors of the present Application.

3. As I further understand it, in the noted rejection of the Application based on U.S. Patent Application Publication 2003/0224286, the Examiner has relied on disclosure relating to the polymer disclosed at paragraph 130 (page 14) of that use of Publication 2003/0224286. The polymer disclosed at paragraph 130 (page 14) U.S. Patent Application Publication 2003/0224286 was conceived and/or reduced to practice solely by me and/or Subareddy Kanagasabapathy. The

contributions of the additional co-inventor of Matthew King on U.S. Patent Application Publication 2003/0224286 were in areas other than such polymer as disclosed at paragraph 130 U.S. Patent Application Publication 2003/0224286.

4. I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title XVIII of the United States Code, and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

Date: 5/17/05



George G. Barclay